

# EMS41GJB-14.8345M

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## REGULATORY COMPLIANCE (Data Sheet downloaded on Nov 22, 2019)


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## ITEM DESCRIPTION

Spread Spectrum MEMS Clock Oscillators LVCMOS (CMOS) 1.8Vdc 4 Pad 2.0mm x 2.5mm Plastic Surface Mount (SMD) 14.8345MHz  $\pm 100$ ppm Maximum over  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  Power Down (Disabled Output Logic Low)  $\pm 0.50\%$  Center Spread

## ELECTRICAL SPECIFICATIONS

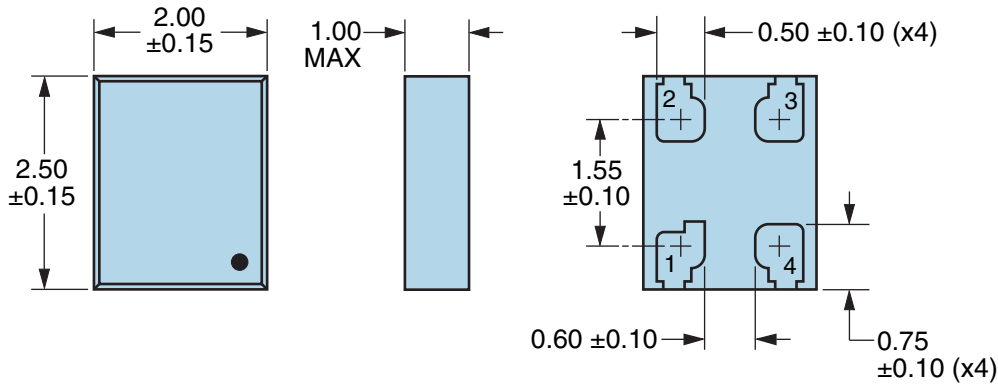
|  |   |
|--|---|
| Nominal Frequency                      | 14.8345MHz  |
| Frequency Tolerance/Stability          | $\pm 100$ ppm Maximum over $-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ (Inclusive of all conditions: Calibration Tolerance at $25^{\circ}\text{C}$ , Frequency Stability over the Operating Temperature Range, Supply Voltage Change, Output Load Change, First Year Aging at $25^{\circ}\text{C}$ , $260^{\circ}\text{C}$ Reflow, Shock, and Vibration) |
| Aging at $25^{\circ}\text{C}$          | $\pm 1$ ppm Maximum First Year  |
| Supply Voltage                         | 1.8Vdc $\pm 5\%$  |
| Maximum Supply Voltage                 | $-0.5\text{Vdc}$ to $+1.98\text{Vdc}$   |
| Input Current                          | 25mA Maximum (Unloaded; Nominal Vdd)  |
| Output Voltage Logic High (Voh)        | 90% of Vdd Minimum (IOH= $-8\text{mA}$ )  |
| Output Voltage Logic Low (Vol)         | 10% of Vdd Maximum (IOL= $+8\text{mA}$ )  |
| Rise/Fall Time                         | 2nSec Maximum (Measured from 20% to 80% of waveform)  |
| Duty Cycle                             | 50 $\pm 5$ (%) (Measured at 50% of waveform)  |
| Load Drive Capability                  | 15pF Maximum  |
| Output Logic Type                      | CMOS  |
| Output Control Function                | Power Down (Disabled Output Logic Low)  |
| Power Down Input Voltage (Vih and Vil) | 70% of Vdd Minimum or No Connection to Enable Output, 30% of Vdd Maximum to Disable Output  |
| Standby Current                        | 50 $\mu\text{A}$ Maximum (Disabled Output: Logic Low) (Pad 1=Ground)  |
| Spread Spectrum                        | $\pm 0.50\%$ Center Spread  |
| Modulation Frequency                   | 30kHz Minimum, 32kHz Typical, 35kHz Maximum   |
| Period Jitter                          | 90pSec Maximum (Cycle to Cycle; Spread Spectrum-On; Fo=133.333M, Vdd=1.8Vdc)  |
| Start Up Time                          | 10mSec Maximum  |
| Storage Temperature Range              | $-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$   |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |   |
|------------------------------|---|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 2, HBM 2000V              |
| Flammability                 | UL94-V0   |
| Mechanical Shock             | MIL-STD-883, Method 2002, Condition G, 30,000G            |
| Moisture Resistance          | MIL-STD-883, Method 1004                                  |
| Moisture Sensitivity Level   | J-STD-020, MSL 1  |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K                      |
| Resistance to Solvents       | MIL-STD-202, Method 215                                   |
| Solderability                | MIL-STD-883, Method 2003 (Pads on Bottom of Package Only) |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B                     |
| Thermal Shock                | MIL-STD-883, Method 1011, Condition B                     |
| Vibration                    | MIL-STD-883, Method 2007, Condition A, 20G                |

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### MECHANICAL DIMENSIONS (all dimensions in millimeters)

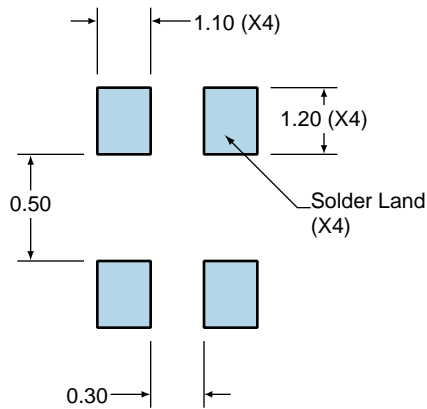


| PIN | CONNECTION             |
|-----|------------------------|
| 1   | Power Down (Logic Low) |
| 2   | Ground                 |
| 3   | Output                 |
| 4   | Supply Voltage         |

| LINE | MARKING   |
|------|---|
| 1    | XXXX or XXXXX<br>XXXX or XXXXX=Ecliptek<br>Manufacturing Identifier |

### Suggested Solder Pad Layout

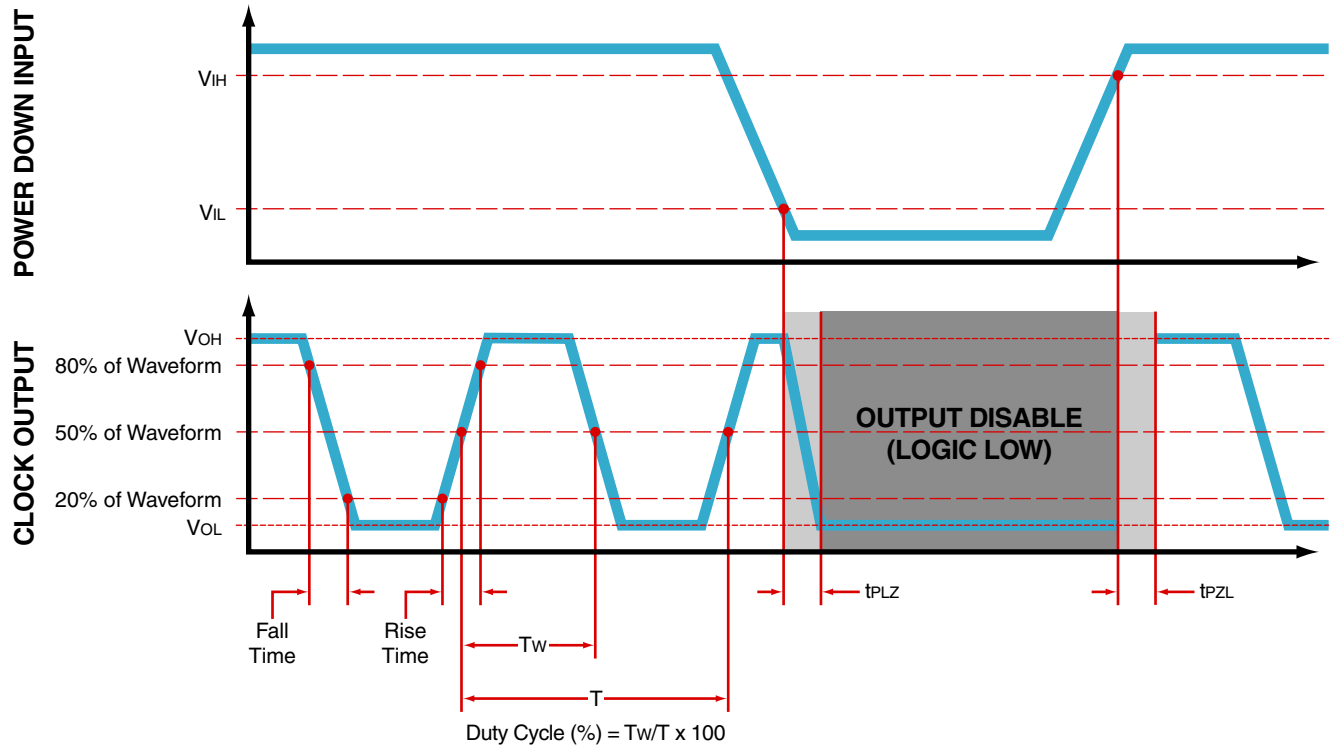
All Dimensions in Millimeters



All Tolerances are  $\pm 0.1$

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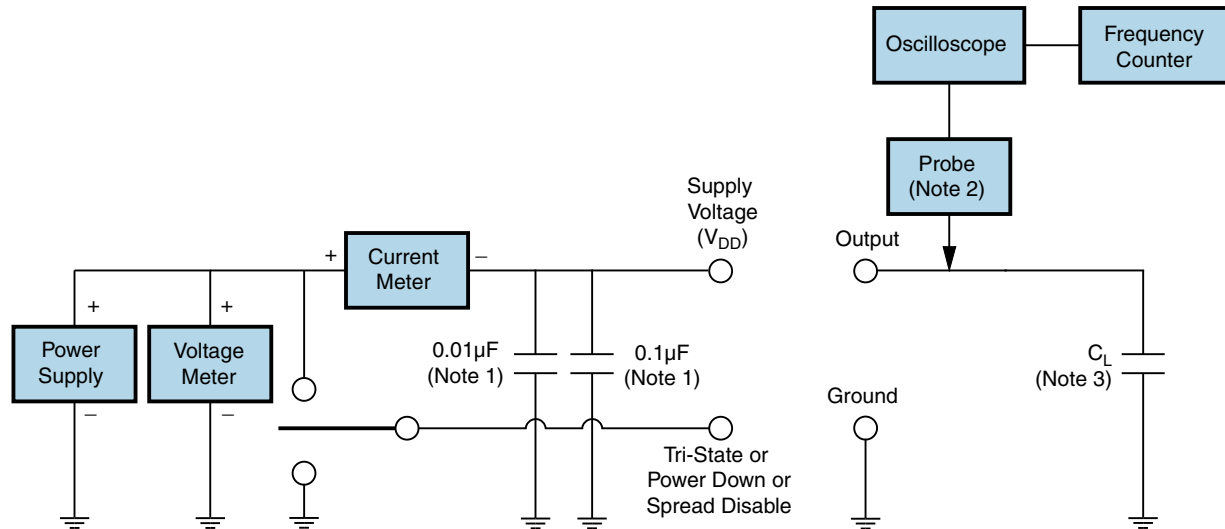
**OUTPUT WAVEFORM & TIMING DIAGRAM**



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## Test Circuit for CMOS Output



Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less than 2mm) to the package ground and supply voltage pin is required.

Note 2: A low capacitance (<12pF), 10X attenuation factor, high impedance (>10Mohms), and high bandwidth (>300MHz) passive probe is recommended.

Note 3: Capacitance value  $C_L$  includes sum of all probe and fixture capacitance.